Electronic Patent Application Fee Transmittal

Application Number:	10679764
Filing Date:	06-Oct-2003
Title of Invention:	Method of forming inter-metal dielectric layer structure
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Filer:	Michael P. Qualey/Denyse Jackson
Attorney Docket Number:	39524.8100

Filed as Large Entity

Utility under 35 USC 111(a) Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD($)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD($)
Miscellaneous:				
Request for continued examination	1801	1	810	810
		Total in USD ($)		**810**